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40 V, 200 mA NPN/NPN switching transistor Rev. 01 — 8 July 2009

Product data sheet

Product profile

1.1 General description

NPN/NPN double switching transistor in a SOT666 ultra small and flat lead Surface-Mounted Device (SMD) plastic package.

Table 1. **Product overview**

Type number	Package F		PNP/PNP	NPN/PNP
	NXP	JEITA	complement	complement
PMBT3904VS	SOT666	-	PMBT3906VS	PMBT3946VPN

1.2 Features

- Double general-purpose switching transistor
- Board-space reduction
- Ultra small and flat lead SMD plastic package

1.3 Applications

■ General-purpose switching and amplification

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
V_{CEO}	collector-emitter voltage	open base	-	-	40	V
I _C	collector current		-	-	200	mA
h _{FE}	DC current gain	$V_{CE} = 1 V;$ $I_{C} = 10 \text{ mA}$	100	180	300	



2. Pinning information

Table 3. Pinning

Table 5.	Filling		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		2 5 4
2	base TR1	6 5 4	6 5 4
3	collector TR2		TR2
4	emitter TR2		(TR1)
5	base TR2	1 2 3	
6	collector TR1	1 2 3	1 2 3
			sym020

3. Ordering information

Table 4. Ordering information

Type number	Package			
	Name	Description	Version	
PMBT3904VS	-	plastic surface-mounted package; 6 leads	SOT666	

4. Marking

Table 5. Marking codes

Type number	Marking code
PMBT3904VS	ZC

5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

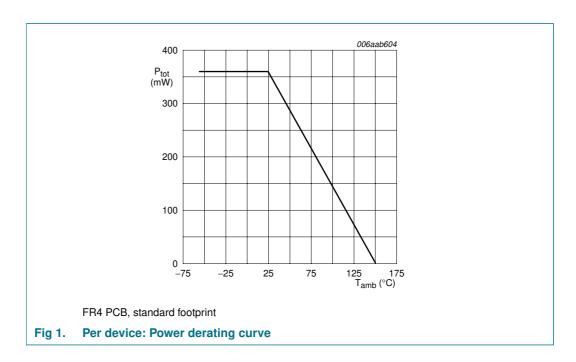
Symbol	Parameter	Conditions	Min	Max	Unit
Per trans	istor				
V_{CBO}	collector-base voltage	open emitter	-	60	V
V_{CEO}	collector-emitter voltage	open base	-	40	V
V_{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	200	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	[1][2]	240	mW
Per devic	e				
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1][2] _	360	mW

Table 6. Limiting values ...continued
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
T _j	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

^[2] Reflow soldering is the only recommended soldering method.



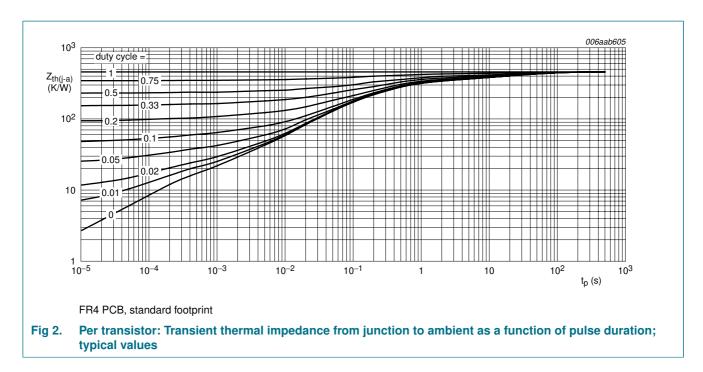
6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transi	istor					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1][2]	-	521	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	100	K/W
Per devic	e					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1][2] _	-	347	K/W

^[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

^[2] Reflow soldering is the only recommended soldering method.



7. Characteristics

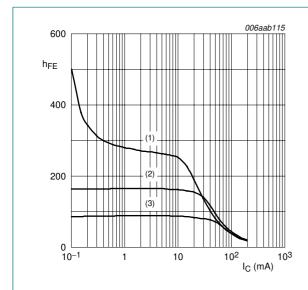
Table 8. Characteristics

T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor					
I _{CBO}	collector-base cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 6 \text{ V}; I_{C} = 0 \text{ A}$	-	-	50	nA
h _{FE}	DC current gain	V _{CE} = 1 V				
		$I_C = 0.1 \text{ mA}$	60	180	-	
		$I_C = 1 \text{ mA}$	80	180	-	
		$I_C = 10 \text{ mA}$	100	180	300	
		$I_C = 50 \text{ mA}$	60	105	-	
		$I_C = 100 \text{ mA}$	30	50	-	
V _{CEsat}	collector-emitter	$I_C = 10 \text{ mA}; I_B = 1 \text{ mA}$	-	75	200	mV
	saturation voltage	$I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$	-	120	300	mV
V _{BEsat}	base-emitter	$I_C = 10 \text{ mA}; I_B = 1 \text{ mA}$	650	750	850	mV
	saturation voltage	$I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$	-	850	950	mV
t _d	delay time	$V_{CC} = 3 \text{ V}; I_{C} = 10 \text{ mA};$	-	-	35	ns
t _r	rise time	$I_{Bon} = 1 \text{ mA};$ $I_{Boff} = -1 \text{ mA}$	-	-	35	ns
t _{on}	turn-on time	180# = -1 IIIV	-	-	70	ns
ts	storage time	-	-	-	200	ns
t _f	fall time		-	-	50	ns
t _{off}	turn-off time		-	-	250	ns

Table 8. Characteristics ...continued $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _c	collector capacitance	$V_{CB} = 5 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	4	pF
C _e	emitter capacitance	$V_{EB} = 500 \text{ mV};$ $I_{C} = i_{c} = 0 \text{ A}; f = 1 \text{ MHz}$	-	-	8	pF
f _T	transition frequency	$V_{CE} = 20 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz	300	-	-	MHz
NF	noise figure	$V_{CE} = 5 \text{ V; } I_{C} = 100 \mu\text{A;}$ $R_{S} = 1 k\Omega;$ f = 10 Hz to 15.7 kHz	-	-	5	dB





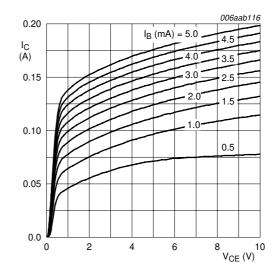
⁽¹⁾ $T_{amb} = 150 \, ^{\circ}C$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = -55 \, ^{\circ}C$$

Fig 3. Per transistor:

DC current gain as a function of collector current; typical values

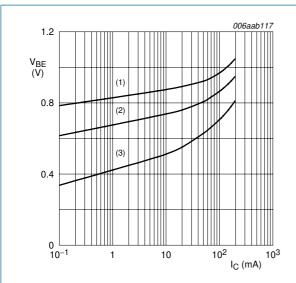


 $T_{amb} = 25 \, ^{\circ}C$

Fig 4. Per transistor:

Collector current as a function of collector-emitter voltage; typical values

40 V, 200 mA NPN/NPN switching transistor



$$V_{CE} = 1 V$$

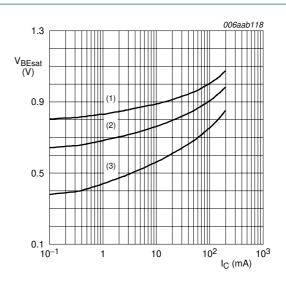
(1)
$$T_{amb} = -55 \,^{\circ}C$$

(2)
$$T_{amb} = 25 \,^{\circ}C$$

(3) $T_{amb} = 150 \, ^{\circ}C$

Fig 5. Per transistor:

Base-emitter voltage as a function of collector current; typical values



$$I_C/I_B = 10$$

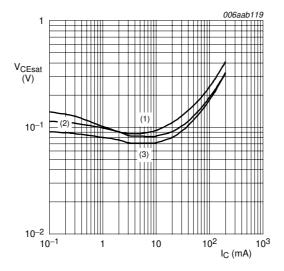
(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 150 \, ^{\circ}C$$

Fig 6. Per transistor:

Base-emitter saturation voltage as a function of collector current; typical values



$$I_C/I_B = 10$$

(1)
$$T_{amb} = 150 \, ^{\circ}C$$

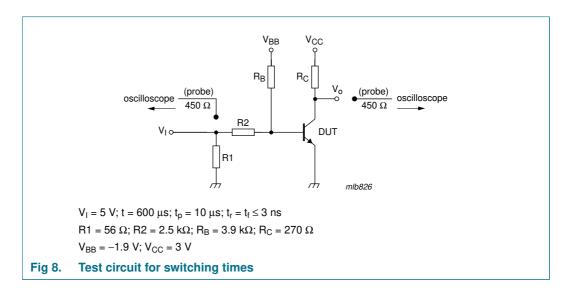
(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = -55 \, ^{\circ}C$

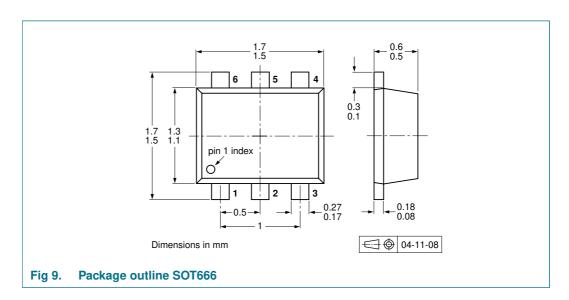
Fig 7. Per transistor: Collector-emitter saturation voltage as a function of collector current; typical values

40 V, 200 mA NPN/NPN switching transistor

8. Test information



9. Package outline



10. Packing information

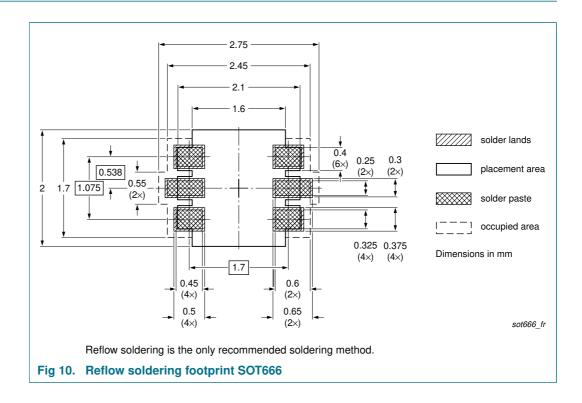
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	age Description Pa		uantity
			4000	8000
PMBT3904VS	SOT666	2 mm pitch, 8 mm tape and reel	-	-315
		4 mm pitch, 8 mm tape and reel	-115	-

^[1] For further information and the availability of packing methods, see Section 14.

11. Soldering





12. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMBT3904VS_1	20090708	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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40 V, 200 mA NPN/NPN switching transistor

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